

Features :

- Isolated mounting base 3000V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

Typical Applications

- Various rectifiers
- DC supply for PWM inverter

V_{RSM}	V_{RRM}	品名
900V	800V	Mx600D80
1100V	1000V	Mx600D100
1300V	1200V	Mx600D120
1500V	1400V	Mx600D140
1700V	1600V	Mx600D160
1900V	1800V	Mx600D180

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j (°C)	VALUE			UNIT
				Min.	Typ.	Max.	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, $T_c=100^\circ C$	150			600	A
I_F (RMS)	RMS forward current		150			942	A
I_{RRM}	Repetitive peak current	at V_{RRM}	150			30	mA
I_{FSM}	Surge forward current	10ms half sine wave $V_R=0.6V_{RRM}$	150			19.0	kA
I^2t	I^2t for fusing coordination					1805	$A^2s \times 10^3$
V_{FO}	Threshold voltage		150			0.75	V
r_F	Forward slope resistance					0.35	$m\Omega$
V_{FM}	Peak forward voltage	$I_{FM}=1800A$	25			1.50	V
$R_{th(j-c)}$	Thermal resistance Junction to case	D.C. Single side cooled per chip				0.065	°C/W
$R_{th(c-h)}$	Thermal resistance case to heatsink	D.C. Single side cooled per chip				0.024	°C/W
V_{iso}	Isolation voltage	50Hz,R.M.S., $t=1min$, $I_{iso}:1mA(max)$		3000			V
F_m	Terminal connection torque(M10)				12.0		N·m
	Mounting torque(M6)				6.0		N·m
T_{vj}	Junction temperature			-40		150	°C
T_{stg}	Stored temperature			-40		125	°C
W_t	Weight				1500		g
Outline		M06					

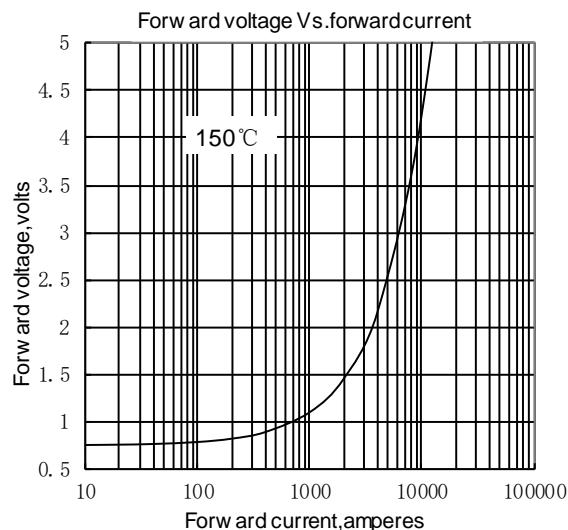


Fig.1

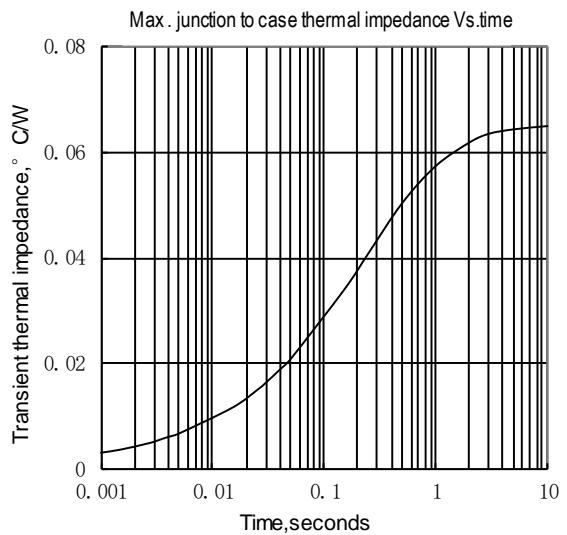


Fig.2

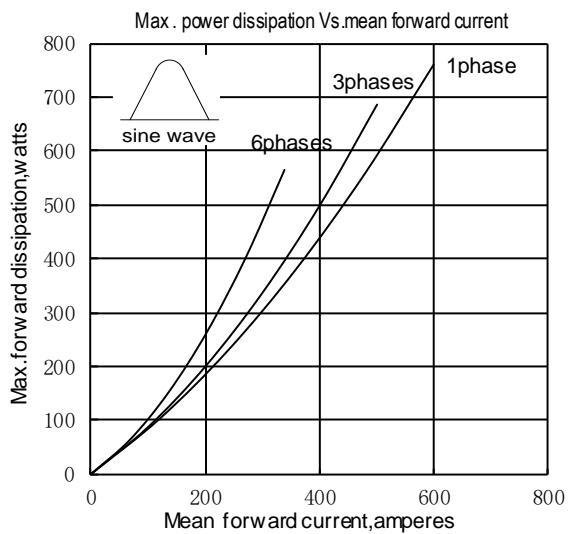


Fig.3

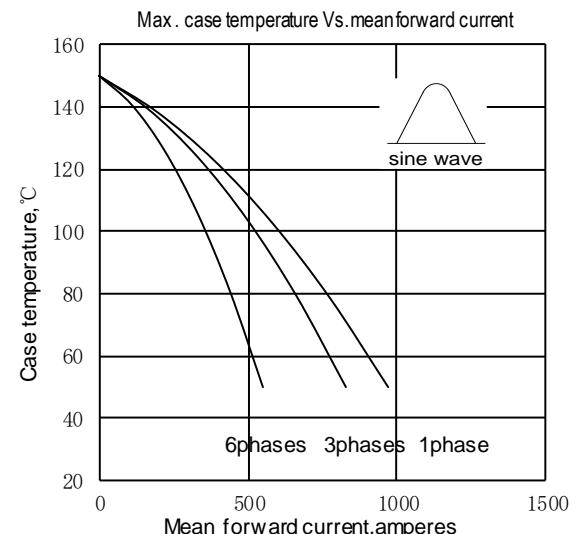


Fig.4

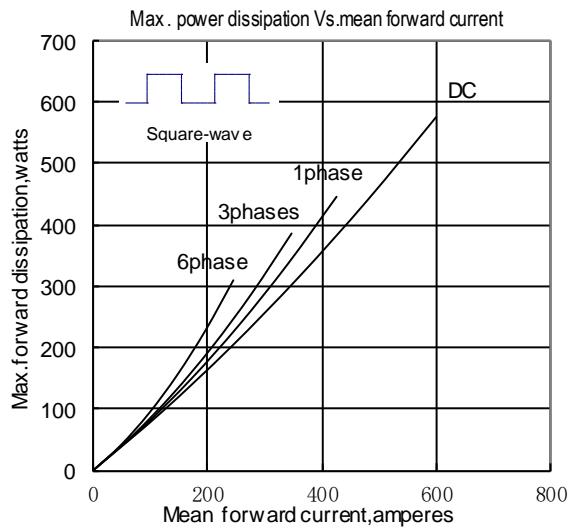


Fig.5

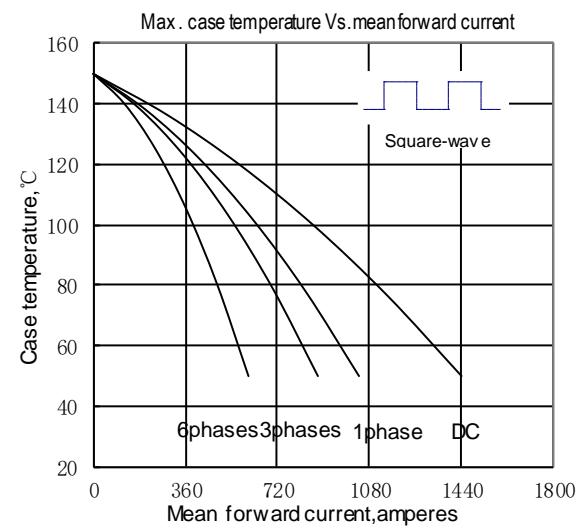


Fig.6

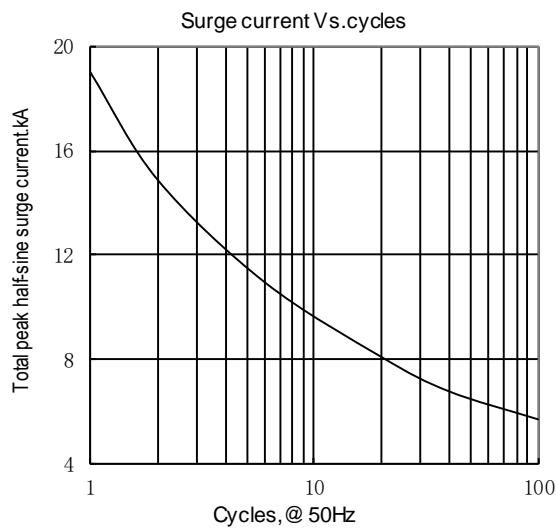
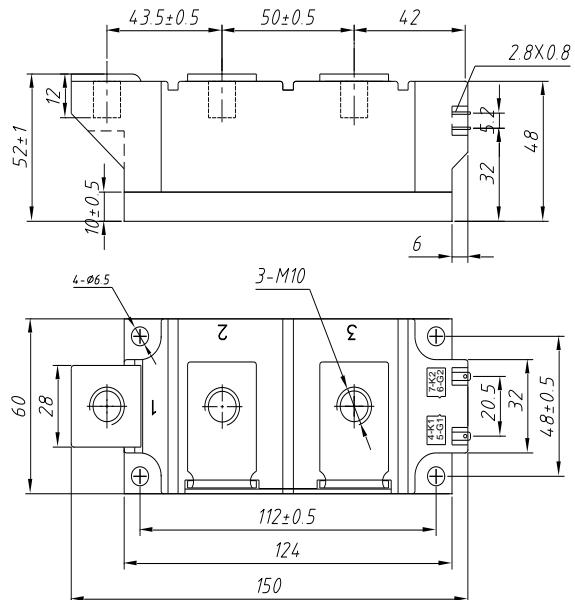
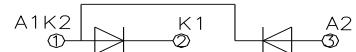


Fig.7



MD600D**



MR600D**



MC600D**

